



# ECG014

## 0.2 Watt, High Linearity InGaP HBT Amplifier

The Communications Edge™

Product Information

### Product Features

- 50 – 2000 MHz
- +23 dBm P1dB
- +39 dBm Output IP3
- 20.5 dB Gain @ 900 MHz
- 17.6 dB Gain @ 1900 MHz
- Single Positive Supply (+8V)
- SOT-89 SMT Package

### Applications

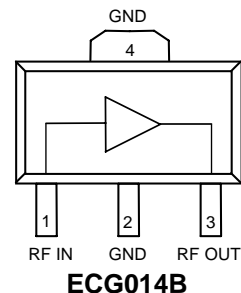
- Mobile Infrastructure
- Defense/Homeland Security

### Product Description

The ECG014 is a high dynamic range driver amplifier in a low-cost surface mount package. The InGaP/GaAs HBT is able to achieve performance over a broad range with +39 dBm OIP3 and +23 dBm of compressed 1-dB power and is housed in an industry standard SOT-89 SMT package. All devices are 100% RF and DC tested.

The product is targeted for use as a gain block/driver amplifier for various current and next generation wireless technologies such as GPRS, GSM and CDMA, where high linearity and medium power is required. In addition, the ECG014 will work for numerous other applications within the 50 to 2000 MHz frequency range.

### Functional Diagram



### Specifications <sup>(1)</sup>

| Parameters                                       | Units | Min   | Typ  | Max  |
|--|-------|-------|------|------|
| Operational Bandwidth                            | MHz   | 50    |      | 2000 |
| Test Frequency                                   | MHz   |       | 900  |      |
| Gain   | dB    | 18.5  | 20.5 |      |
| Output P1dB                                      | dBm   | +22   | +23  |      |
| Output OIP3 <sup>(2)</sup>                       | dBm   | +38   | +39  |      |
| Test Frequency                                   | MHz   |       | 1900 |      |
| Gain   | dB    | 17    | 17.6 |      |
| Input Return Loss                                | dB    |       | 17   |      |
| Output Return Loss                               | dB    |       | 7.4  |      |
| Output P1dB                                      | dBm   |       | +23  |      |
| Output IP3 <sup>(2)</sup>                        | dBm   | +36.5 | +38  |      |
| IS-95A Channel Power<br>@ -45 dBc ACPR, 1900 MHz | dBm   |       | +16  |      |
| Noise Figure                                     | dB    |       | 5.2  |      |
| Operating Current Range <sup>(3)</sup>           | mA    | 85    | 100  | 135  |
| Device Voltage <sup>(4)</sup>                    | V     |       | 5    |      |

1. Test conditions unless otherwise noted: 25 °C, V<sub>supply</sub> = +8V, in tuned application circuit with R<sub>bias</sub> = 30 Ω.
2. 3OIP measured with two tones at an output power of +9 dBm/tone separated by 1 MHz. The suppression on the largest IM3 product is used to calculate the 3OIP using a 2:1 rule. The tuned application circuit is tuned for optimum ACPR performance. An improvement in OIP3 of 2 to 3 dB can be achieved for tuning for optimum OIP3 (with slightly degraded ACPR performance).
3. This corresponds to the quiescent current or operating current under small-signal conditions.
4. This device requires a minimum 7 V power supply through a dropping resistor. 8 V and 30 ohms are recommended for proper operation. Operation of the device directly to a 5 V supply could lead to thermal damage to the device.

### Typical Performance <sup>(5)</sup>

| Parameters                                       | Units | Typical       |      |
|--|-------|---------------|------|
| Frequency  | MHz   | 900           | 1900 |
| S21 – Gain                                       | dB    | 20.5          | 17.6 |
| S11 – Input R.L.                                 | dB    | -20           | -17  |
| S22 – Output R.L.                                | dB    | -9.5          | -7.4 |
| Output P1dB                                      | dBm   | +22.8         | +23  |
| Output IP3 <sup>(2)</sup>                        | dBm   | +39           | +38  |
| IS-95A Channel Power<br>@ -45 dBc ACPR, 1900 MHz | dBm   | +17           | +16  |
| Noise Figure                                     | dB    | 5             | 5.2  |
| Supply Bias                                      |       | +8 V @ 100 mA |      |

5. Typical parameters reflect performance in a tuned application circuit: Supply Voltage = +8 V, I<sub>cc</sub> = 100 mA, +25° C, R<sub>bias</sub> = 30 Ω.

### Absolute Maximum Rating

| Parameters                  | Rating         |
|-----------------------------|----------------|
| Operating Case Temperature  | -40 to +85 °C  |
| Storage Temperature         | -65 to +150 °C |
| RF Input Power (continuous) | +12 dBm        |
| Device Voltage              | +6 V           |
| Device Current              | 150 mA         |
| Device Power                | 1.5 W          |
| Junction Temperature        | +250 °C        |

Operation of this device above any of these parameters may cause permanent damage.

### Ordering Information

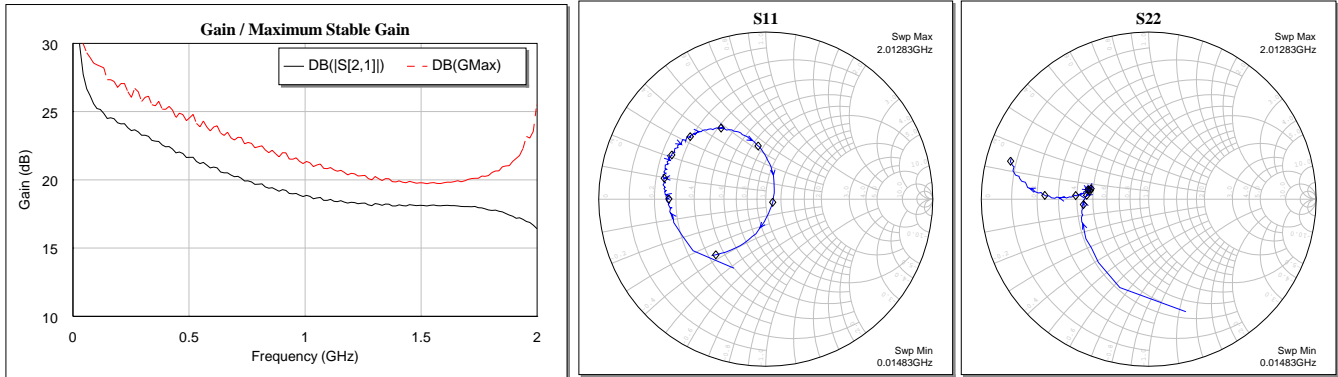
| Part No.        | Description                                  |
|-----------------|--|
| ECG014B         | 0.2 Watt, High Linearity InGaP HBT Amplifier |
| ECG014B-PCB900  | 900 MHz Evaluation Board                     |
| ECG014B-PCB1900 | 1900 MHz Evaluation Board                    |

Specifications and information are subject to change without notice



### Typical Device Data

S-parameters ( $V_{device} = +5V$ ,  $I_{cc} = 100\text{ mA}$ ,  $25^\circ\text{ C}$ , unmatched 50 ohm system)



Notes:

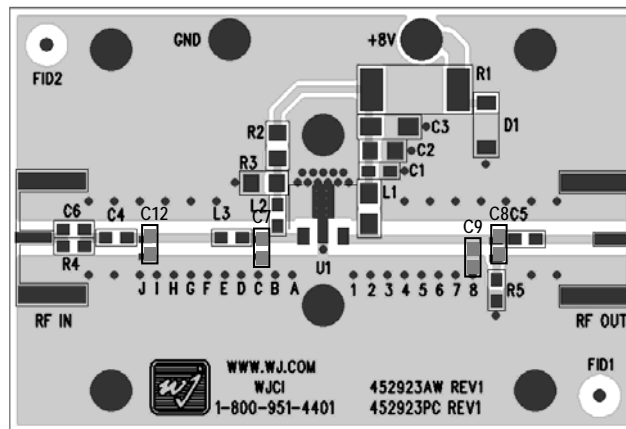
The gain for the unmatched device in 50 ohm system is shown as the trace in blue color. For a tuned circuit for a particular frequency, it is expected that actual gain will be higher, up to the maximum stable gain. The maximum stable gain is shown in the dashed red line. The impedance plots are shown from 50 – 2500 MHz, with markers placed at 0.25 – 2 GHz in 0.25 GHz increments.

S-Parameters ( $V_{device} = +5\text{ V}$ ,  $I_{cc} = 100\text{ mA}$ ,  $T = 25^\circ\text{ C}$ , unmatched 50 ohm system, calibrated to device leads)

| Freq (MHz) | S11 (dB) | S11 (ang) | S21 (dB) | S21 (ang) | S12 (dB) | S12 (ang) | S22 (dB) | S22 (ang) |
|------------|----------|-----------|----------|-----------|----------|-----------|----------|-----------|
| 50         | -5.21    | -158.20   | 27.34    | 141.96    | -32.11   | 16.29     | -6.58    | -132.30   |
| 100        | -4.92    | -170.08   | 25.32    | 144.95    | -31.61   | 9.45      | -7.49    | -157.02   |
| 200        | -4.72    | -177.73   | 24.15    | 138.50    | -31.37   | 6.88      | -7.96    | -171.72   |
| 400        | -4.31    | 173.22    | 22.43    | 118.30    | -30.63   | 7.98      | -8.46    | 178.73    |
| 600        | -4.10    | 163.26    | 20.91    | 100.56    | -30.32   | 5.52      | -8.81    | 174.06    |
| 800        | -4.19    | 152.57    | 19.68    | 85.04     | -29.78   | 2.65      | -9.07    | 171.40    |
| 1000       | -4.63    | 140.41    | 18.82    | 69.98     | -29.74   | -2.18     | -9.12    | 169.67    |
| 1200       | -5.64    | 126.43    | 18.35    | 54.85     | -29.31   | -11.26    | -8.95    | 170.98    |
| 1400       | -7.84    | 109.08    | 18.13    | 38.12     | -29.86   | -26.72    | -8.04    | 175.14    |
| 1600       | -13.52   | 83.27     | 18.12    | 17.54     | -31.16   | -52.52    | -6.16    | 179.09    |
| 1800       | -19.89   | -85.25    | 17.78    | -7.75     | -34.99   | -105.12   | -3.43    | 176.43    |
| 2000       | -6.99    | -131.98   | 16.44    | -37.07    | -34.48   | 161.53    | -1.36    | 164.56    |
| 2200       | -2.84    | -160.75   | 14.09    | -64.48    | -29.33   | 106.22    | -0.69    | 149.67    |
| 2400       | -1.18    | 177.40    | 10.90    | -86.11    | -26.64   | 75.52     | -0.93    | 136.25    |
| 2500       | -0.78    | 167.87    | 9.28     | -96.04    | -25.96   | 66.16     | -1.28    | 130.16    |

Device S-parameters are available for download off of the website at: <http://www.wj.com>

### Application Circuit PC Board Layout



Circuit Board Material: .014" Getek, 4 - layer, 1 oz copper, Microstrip line details: width = .026", spacing = .026"  
 The silk screen markers 'A', 'B', 'C', etc. and '1', '2', '3', etc. are used as placemarkers for the input and output tuning shunt capacitors. The markers and vias are spaced in .050" increments.  
 C7/C8 are for 900 MHz matching circuits and C9/C12 are for 1900 MHz matching circuits.

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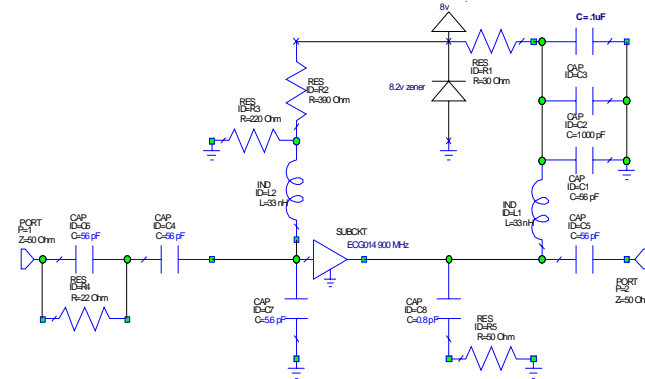


## 900 MHz Application Circuit (ECG014B-PCB900)

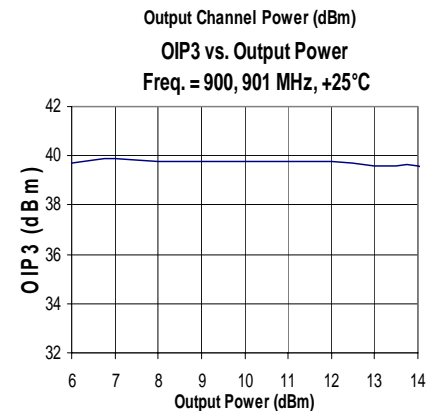
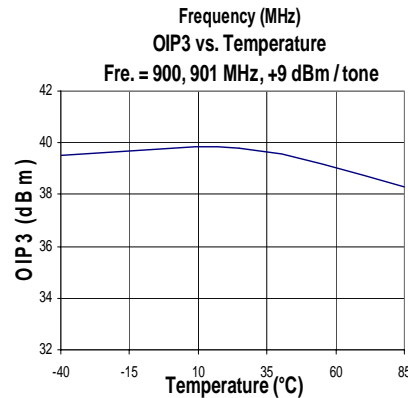
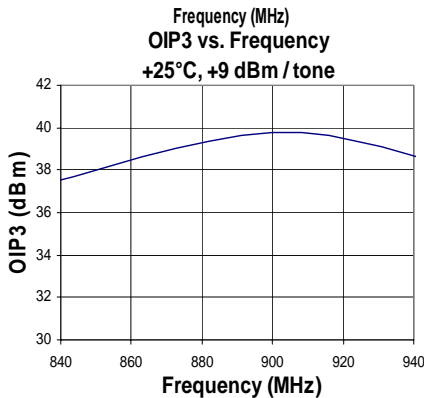
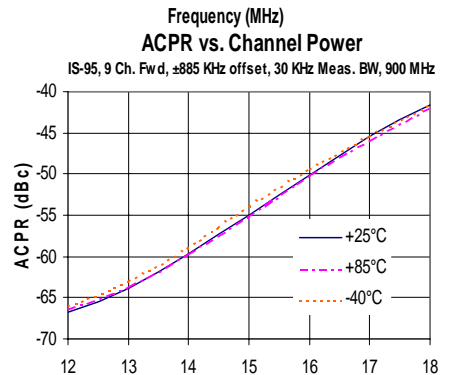
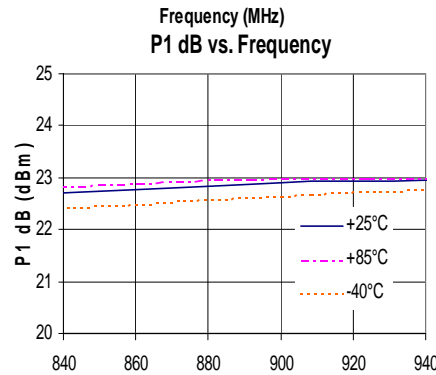
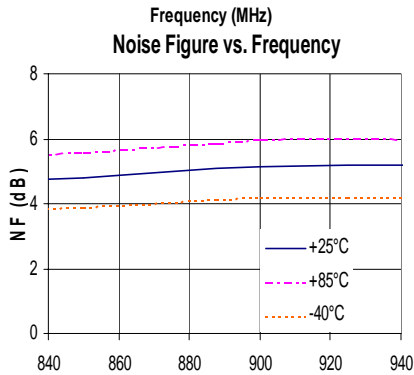
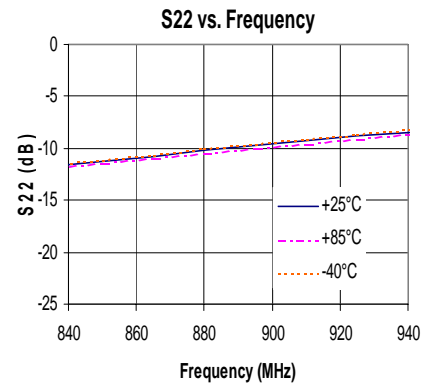
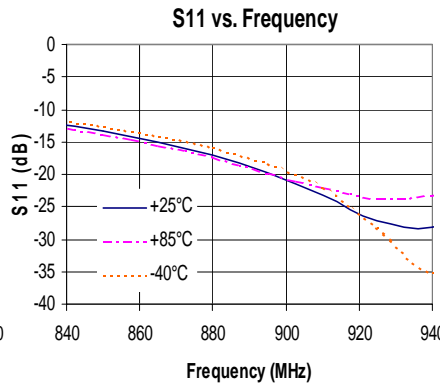
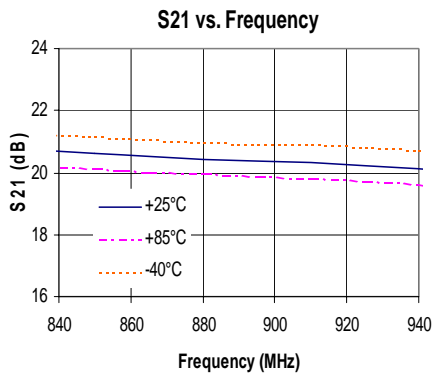
### Typical RF Performance at 25°C

| Frequency   | 900 MHz   |
|---|-----------|
| S21 – Gain  | 20.5 dB   |
| S11 – Input Return Loss                                 | -20 dB    |
| S22 – Output Return Loss                                | -9.5 dB   |
| Output P1dB   | +22.8 dBm |
| Output IP3*<br>(+9 dBm / tone, 1 MHz spacing)           | +39 dBm   |
| Channel Power<br>(@ -45 dBc ACPR, IS-95 9 channels fwd) | +17 dBm   |
| Noise Figure  | 5 dB      |
| Device Voltage  | +5 V      |
| Quiescent Current                                       | 100 mA    |

\* Please see note 2 on page 1.



C7 is placed at silkscreen marker 'C' or center of component placed at 5.6 deg. @ 900 MHz away from pin 1. C8 is placed at 22 deg. @ 900 MHz away from pin 3.



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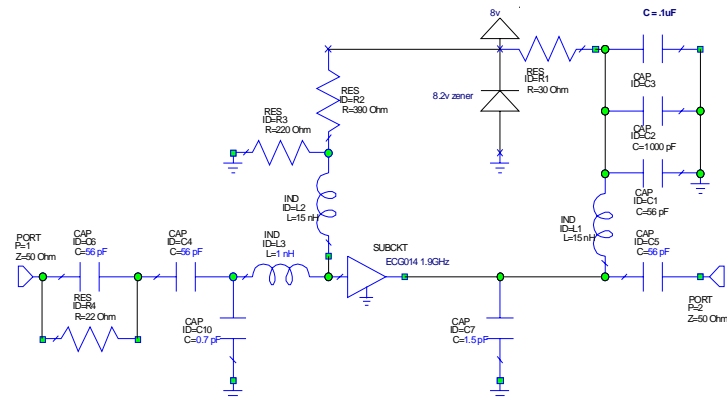


## 1900 MHz Application Circuit (ECG014B-PCB1900)

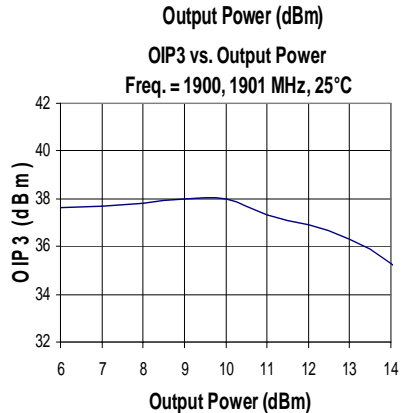
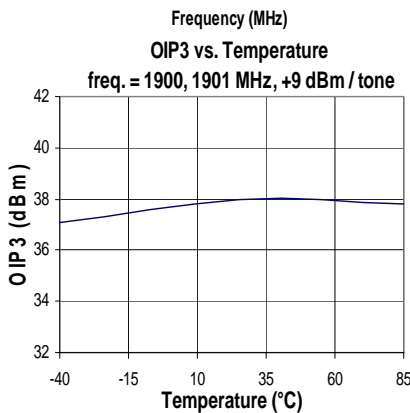
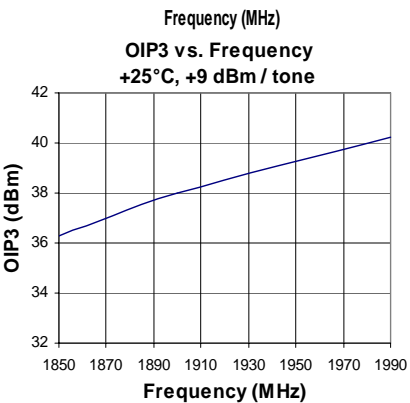
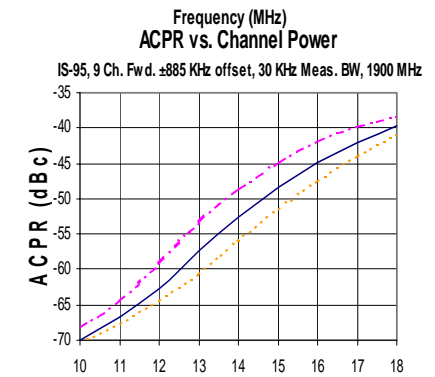
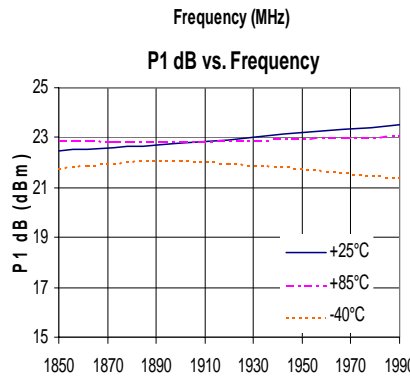
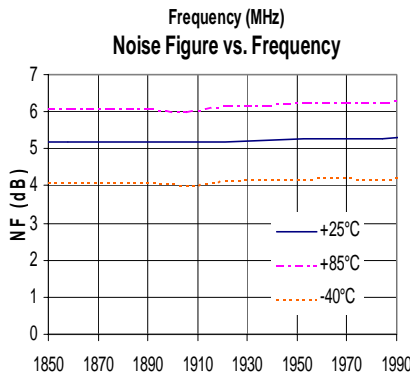
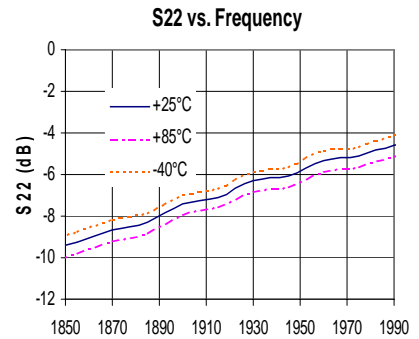
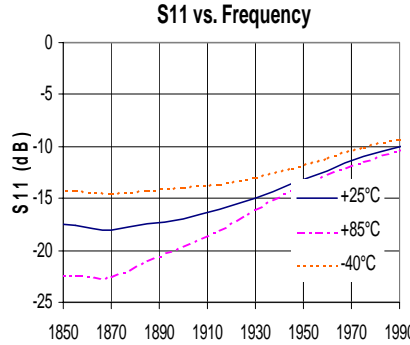
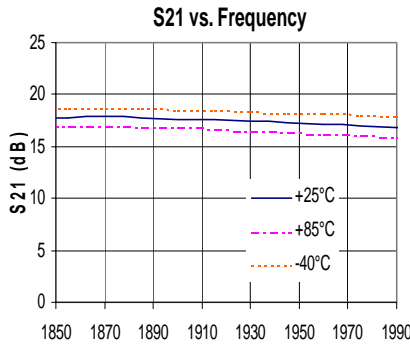
### Typical RF Performance at 25°C

| Frequency   | 1900 MHz |
|---|----------|
| S21 – Gain  | 17.6 dB  |
| S11 – Input Return Loss                                 | -17 dB   |
| S22 – Output Return Loss                                | -7.4 dB  |
| Output P1dB   | +23 dBm  |
| Output IP3*<br>(+9 dBm / tone, 1 MHz spacing)           | +38 dBm  |
| Channel Power<br>(@ -45 dBc ACPR, IS-95 9 channels fwd) | +16 dBm  |
| Noise Figure  | 5.2 dB   |
| Device Voltage  | +5 V     |
| Quiescent Current                                       | 100 mA   |

\* Please see note 2 on page 1.



C9 placed at silkscreen marker '8' or center of component placed at 39 deg. @ 1900 MHz away from pin 1.  
C12 is placed at silkscreen marker 'I' or center of component placed at 43 deg. @ 1.9 GHz away from pin 1.



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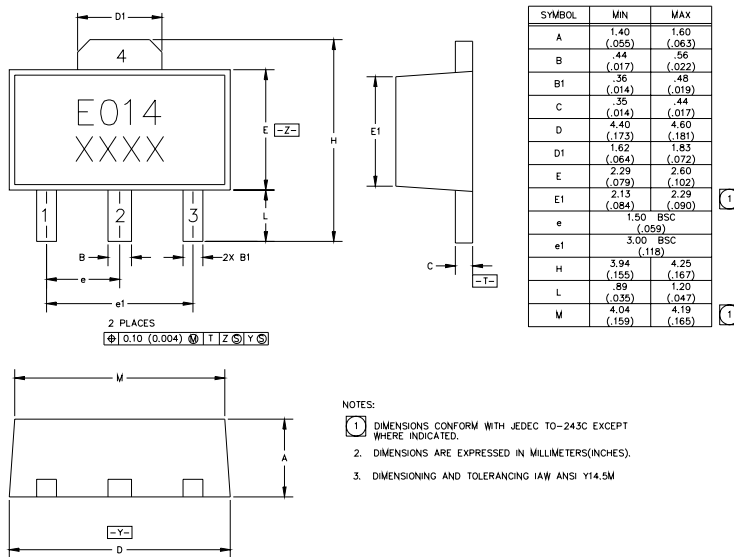
# ECG014

## 0.2 Watt, High Linearity InGaP HBT Amplifier

The Communications Edge™

Product Information

### Outline Drawing



### Product Marking

The component will be marked with an "E014" designator with an alphanumeric lot code on the top surface of the package.

Tape and reel specifications for this part are located on the website in the "Application Notes" section.

### ESD / MSL Information



Caution! ESD sensitive device.

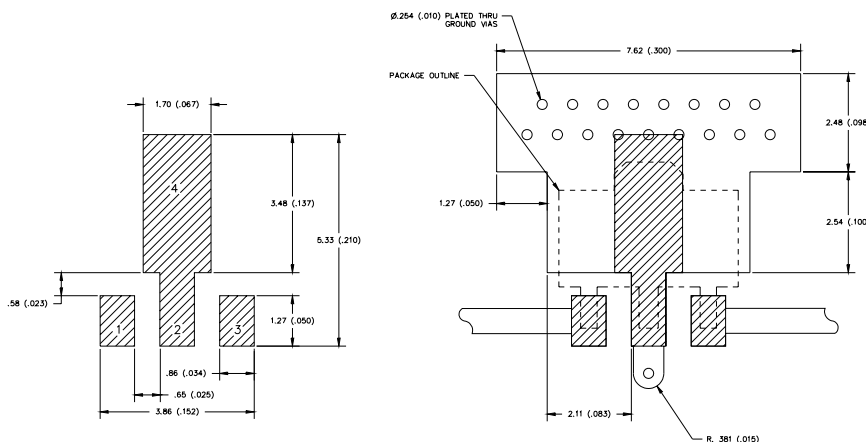
ESD Rating: Class 1B  
 Value: Passes between 500 and 1000V  
 Test: Human Body Model (HBM)  
 Standard: JEDEC Standard JESD22-A114

MSL Rating: Level 3 at +235° C convection reflow  
 Standard: JEDEC Standard J-STD-020

### Mounting Config. Notes

1. Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
3. Mounting screws can be added near the part to fasten the device to a heatsink. Ensure that the ground / thermal via region contacts the heatsink.
4. Do not put solder mask on the backside of the PC board in the region where the board contacts the heatsink.
5. RF trace width depends upon the PC board material and construction.
6. Use 1 oz. Copper minimum.
7. All dimensions are in millimeters (inches). Angles are in degrees.

### Land Pattern

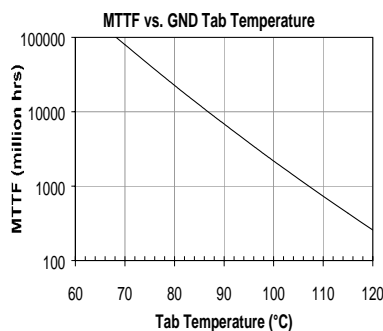


### Thermal Specifications

| Parameter                                | Rating        |
|--|---------------|
| Operating Case Temperature               | -40 to +85° C |
| Thermal Resistance, Rth <sup>(1)</sup>   | 128° C / W    |
| Junction Temperature, Tjc <sup>(2)</sup> | 149° C        |

Notes:

1. The thermal resistance is referenced from the junction-to-case at a case temperature of 85° C.
2. This corresponds to the typical biasing condition of +5V, 100 mA at an 85° C case temperature. A minimum MTTF of 1 million hours is achieved for junction temperatures below 247° C.



Specifications and information are subject to change without notice